

N-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
150	0.375 at V _{GS} = 10 V	1.5		
	0.400 at V _{GS} = 6.0 V	1.4		

FEATURES

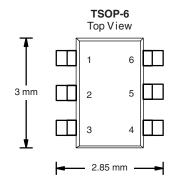
- TrenchFET® Power MOSFET
- PWM Optimized for Fast Switching In Small Footprint



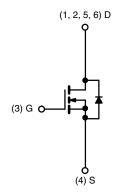
• 100 % R_g Tested

APPLICATIONS

• Primary Side Switch for Low Power DC/DC Converters



Ordering Information: Si3440DV-T1-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T	_A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	150		V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current /T 175 °C\8	T _A = 25 °C	- I _D	1.5	1.2	
Continuous Drain Current (T _J = 175 °C) ^a	T _A = 85 °C		1.1	0.8	Δ.
Pulsed Drain Current		I _{DM}	6		Α
Single Avalanche Current	L = 0.1 mH	I _{AS}	4		
Single Avalanche Energy (Duty Cycle ≤ 1 %)	L=0.1 mm	E _{AS}	0.8		mJ
Continuous Source Current (Diode Conduction) ^a		I _S	1.7	1.0	Α
	T _A = 25 °C	- P _D	2.0	1.14	W
Maximum Power Dissipation ^a	T _A = 85 °C		1.0	0.59	VV
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mariana baratian ta Ambianta	t ≤ 5 s	R _{thJA}	45	62.5	°C/W
Maximum Junction-to-Ambient ^a	Steady State		90	110	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	25	30	

Notes

a. Surface Mounted on 1" x 1" FR4 board.

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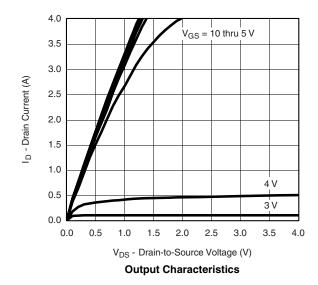
SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	٧		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA		
Zoro Coto Voltogo Droin Current		V _{DS} = 150 V, V _{GS} = 0 V	1		1	μА		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V, T _J = 85 °C			5			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	4			Α		
	D	V _{GS} = 10 V, I _D = 1.5 A		0.310	0.375	0		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 6.0 V, I _D = 1.4 A		0.330	0.400	Ω		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 1.5 A		4.1		S		
Diode Forward Voltage ^a	V_{SD}	I _S = 1.7 A, V _{GS} = 0 V		0.8	1.2	٧		
Dynamic ^b								
Total Gate Charge	Q_g			5.4	8			
Gate-Source Charge	Q_{gs}			1.1		nC		
Gate-Drain Charge	Q_{gd}			1.9				
Gate Resistance	R_g	f = 1 MHz	4	9	15	Ω		
Turn-On Delay Time	t _{d(on)}			8	15			
Rise Time	t _r	$V_{DD} = 75 \text{ V}, R_L = 75 \Omega$		10	15			
Turn-Off Delay Time	$t_{d(off)}$ $I_D \cong 1 \text{ A, } V_{GEN} = 10 \text{ V, } R_G = 6 \Omega$		20	30	ns			
Fall Time	t _f			15	25			
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = 1.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		40	60			

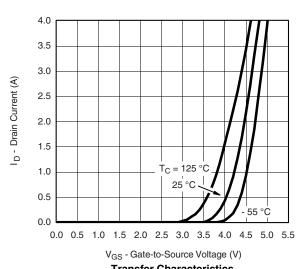
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





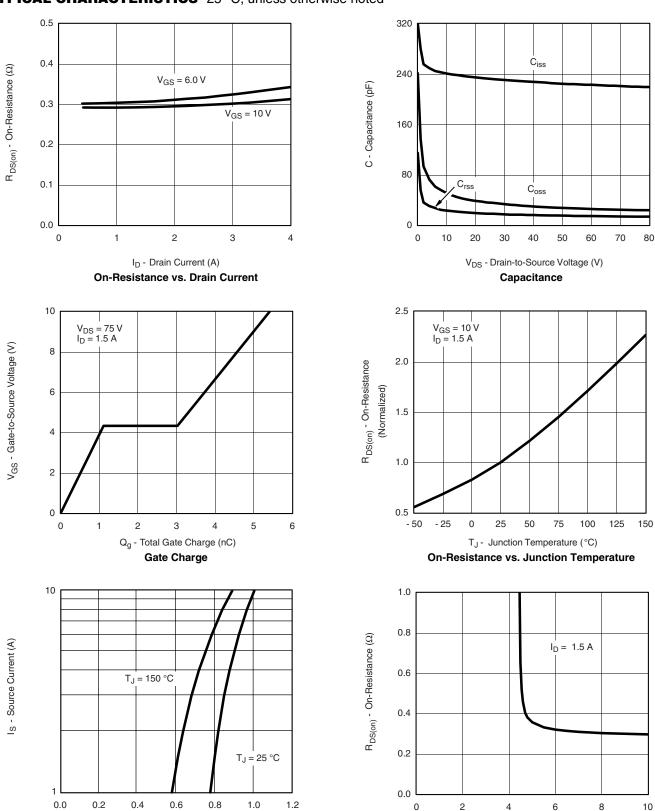
Transfer Characteristics







TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

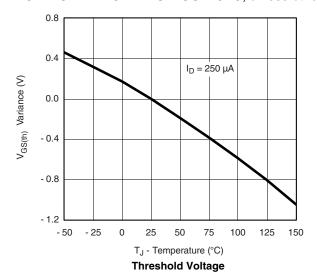
V_{GS} - Gate-to-Source Voltage (V)

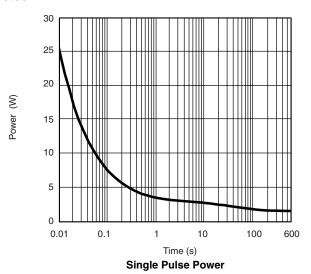
On-Resistance vs. Gate-to-Source Voltage

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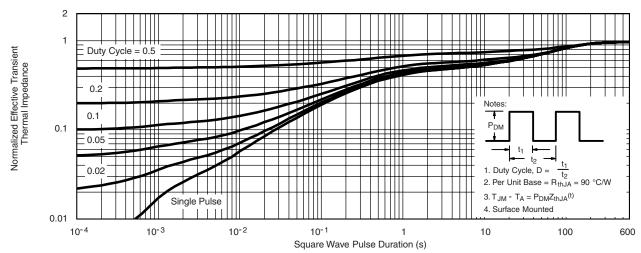
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





10 I_{DM} Limited Limited by R_{DS(o)} P(t) = 0.0001I_D - Drain Current (A) P(t) = 0.001I_{D(on)} Limited 0.1 P(t) = 10T_A = 25 °C 0.01 Single Pulse **BVDSS Limited** 0.001 0.1 V_{DS} - Drain-to-Source Voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

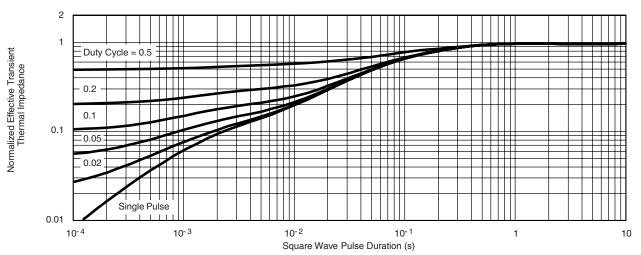
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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